

IMPROVED NIGHT VISION DEVICE AND METHOD

Background of the Invention

Field of the Invention

The present invention is in the field of night vision devices. More particularly, the present invention relates to a night vision device which uses an image intensifier tube to amplify light from a scene. This light may be too dim to be seen with natural human vision, or the scene may be illuminated substantially only by infrared light which is invisible to human vision. The image 5 intensifier tube both amplifies the image from the scene and shifts the wavelength of the image into the portion of the spectrum which is visible to humans, thus to provide a visible image replicating the scene. Still more particularly, the present invention relates to such an image intensifier tube having a unitary ceramic body portion, as well as a photocathode and a microchannel plate spaced from one another to define a spacing dimension, this dimension being established by structure 10 extending axially between the photocathode microchannel plate, and establishing this spacing dimension independently of tolerances and variability's of the other components of the image intensifier tube. Methods of making of operating such an image intensifier tube are presented.

Related Technology

15 Even on a night which is too dark for natural human vision, invisible infrared light is richly provided in the near-infrared portion of the spectrum by the stars of the night sky. Human vision cannot utilize this infrared light from the stars because the infrared portion of the spectrum is invisible to humans. Under such conditions, a night vision device (NVD) of the light amplification type can provide a visible image replicating a night-time scene. Such NVD's 20 generally include an objective lens which focuses invisible infrared light from the night-time scene through the transparent light-receiving face of an image intensifier tube (I²T). At its opposite image-output face, the I²T provides a visible image, generally in yellow-green phosphorescent light. This image is then presented via an eyepiece lens to a user of the device.

A contemporary NVD will generally use an I²T with a photocathode (PC) behind the 25 light-receiving face of the tube. The PC is responsive to photons of visible and infrared light to liberate photoelectrons. Because an image of a night-time scene is focused on the PC, photoelectrons are liberated from the PC in a pattern which replicates the scene. These photoelectrons are moved by a prevailing electrostatic field to a microchannel plate having a

great multitude of microchannels, each of which is effectively a dynode. These microchannels have an interior surface at least in part defined by a material liberating secondary-emission electrons when photoelectrons collide with the interior surfaces of the microchannels. In other words, each time an electron (whether a photoelectron or a secondary-emission electron 5 previously emitted by the microchannel plate) collides with this material at the interior surface of the microchannels, more than one electron (i.e., secondary-emission electrons) leaves the site of the collision. This process of secondary-electron emissions is not an absolute in each case, but is a statistical process having an average emissivity of greater than unity.

As a consequence, the photoelectrons entering the microchannels cause a geometric 10 cascade of secondary-emission electrons moving along the microchannels, from one face of the microchannel plate to the other so that a spatial output pattern of electrons (which replicates the input pattern; but at an electron density which may be, for example, from one to several orders of magnitude higher) issues from the microchannel plate.

This pattern of electrons is moved from the microchannel plate to a phosphorescent 15 screen electrode by another electrostatic field. When the electron shower from the microchannel plate impacts on and is absorbed by the phosphorescent screen electrode, visible-light phosphorescence occurs in a pattern which replicates the image. This visible-light image is passed out of the tube for viewing via a transparent image-output window.

The necessary electrostatic fields for operation of an I²T are provided by an electronic 20 power supply. Usually a battery provides the electrical power to operate this electronic power supply so that many of the conventional NVD's are portable.

However, the electrostatic fields maintained within a conventional image intensifier tube, which are effective to move electrons from the photocathode to the screen electrode, also are unavoidably effective to move any positive ions which exist within the image intensifier tube 25 toward the photocathode. Because such positive ions may include the nucleus of gas atoms of considerable size (i.e., of hydrogen, oxygen, and nitrogen, for example, all of which are much more massive than an electron), these positive gas ions are able to impact upon and cause physical and chemical damage to the photocathode. An even greater population of gas atoms present within a conventional image intensifier tube may be electrically neutral but also may be 30 effective to chemically combine with and poison the photocathode.

Conventional image intensifier tubes have an unfortunately high indigenous population of gas atoms within the tube – both those gas atoms which become positive ions and those much more populous atoms that remain electrically neutral but are possible of chemically reacting within the tube. Historically, this indigenous population of gas atoms resulted both in the impact 5 of many positive ions on the photocathode, and in chemical attack of the photocathode. With many early-generation I²T's, this resulted in a relatively short operating life.

As those ordinarily skilled in the pertinent arts will understand, later generation I²T's of the proximity focus type have partially solved this ion-impact and chemical reaction problem by providing an ion barrier film on the inlet side of the MCP. This ion barrier film both blocks the 10 positive ions and prevents them from damaging the PC, and inhibits the migration of chemically active atoms toward the PC. However, the ion barrier film on a MCP is itself the source of many disadvantages.

A recognized disadvantage of such an ion barrier film on an MCP is the resulting decrease in effective signal-to-noise ratio provided by the MCP between a PC of an I²T and the 15 output screen electrode of the tube. That is, although the material of the ion barrier film itself acts as a secondary emitter of electrons, but only for those electrons of sufficient energy. Electrons of lower energy may be absorbed by the ion barrier film, so that this ion barrier film acts to prevent these low energy electrons from reaching the microchannels of the MCP. Secondary-emission electrons typically have a comparatively low energy. Recalling that about 20 50% of the electron input face of a MCP is open area, and about the same percentage is defined by the solid portion or web of the microchannel plates, it is easily appreciated that about half of the photoelectrons impact on the web of the MCP. Moreover, these photoelectrons which impact the web of the MCP result in the production of secondary emission electrons closely adjacent to the open areas of the MCP, and with low energies. These low-energy electrons lack the energy to 25 either penetrate the ion barrier film, or to cause this film to liberate secondary electrons. So these low energy electrons are absorbed by the ion barrier film. The result is that in some cases, as much as 50% of the electrons that would otherwise contribute to the formation of an image by the I²T are blocked or absorbed by the ion barrier film and do not reach the microchannels to be amplified as described above. Thus, about the same percentage of the image information which 30 theoretically could be provided by the tube is lost.

Another disadvantage of the ion barrier film is that it contributes to halo effect in the image provided by the conventional image intensifier tube. This halo effect may be visualized as photoelectrons incident on the web of the MCP, or on the ion barrier film itself, either themselves not penetrating this film to enter a microchannel and to be amplified, but bouncing 5 off to again impact the film or the web at another location. At the other location, the process is repeated, with some of the electrons entering a microchannel, and some of the electrons again bouncing to yet a third location. This effect causes a halo or emission of light around locations of the image. This halo light emission does not correspond to a bright area of the scene being viewed. This halo effect reduces the quality of the image provided by an image intensifier tube, 10 and reduces contrast values in this image.

Another problem with image intensifier tubes using an ion barrier film is the electron voltage that must be provided (i.e., by the use of a higher applied voltage between the PC and the MCP) to photoelectrons simply to compensate on a statistical basis for the electron barrier which is represented by the film itself. The ion barrier film itself requires about 600 to 700 volts of 15 additional applied potential.

Yet another source of image halo in conventional MCP's results from the excessive distance maintained between the PC and the front face of the MCP in these conventional I²T's. The conventional I²T's generally have a gap from PC to MCP no less than about 250 μ meter (+ or - about 25 μ meter). It is recognized that an important factor in the extent or degree of halo 20 effect is the spacing between the PC and the MCP of an I²T. However, conventional I²T's have not been able to provide a spacing as small at that achieved by the present invention.

United States patents No. 3,720,535, issued 13 March 1973; 3,742,224, issued 26 June 1973; and 3,777,201, issued 4 December 1973 provide examples of microchannel plates or image intensifier tubes having an ion barrier film on a microchannel plate. Also, a construction of 25 microchannel plate relevant to this present invention is taught in US patent No. 5,493,111, owned by the assignee of this present application, and on which the inventor of this present application is also a joint inventor.

Summary of the Invention

30 In view of the deficiencies of the conventional related technology, it is desirable and is an object of this invention to provide a night vision device which avoids or reduces the severity of one or more of these deficiencies.

Further, it is an object for this invention to provide an image intensifier tube which overcomes or reduces the severity of at least one deficiency of the conventional technology.

Thus, it is desirable and is an object for this invention to provide an improved I^2T having a spacing between the PC and the MCP of the tube which is independent of tolerances or 5 variability's of the body of the tube.

More particularly, the present invention relates to an improved I^2T having an improved housing with a portion formed of ceramic or other insulative material, and which portion provides for electrical contact with a MCP of the tube, and also allows the spacing of this MCP from the PC of the tube to be determined by a PC-to-MCP spacer(s) extending axially between 10 the PC and MCP of the tube.

An additional object and advantage of this invention is the provision of an I^2T having a high-voltage power supply in the form of an annulus which is axially aligned and stacked with the tube body (i.e., rather than in the form of an annulus surrounding the tube body), so that the envelope diameter of the tube is made smaller in comparison with conventional tubes.

15 Still further, an object for and advantage of this invention is the provision of an I^2T having a tube body with no radially outwardly exposed or provided electrical contacts. In other words, the ceramic or other insulative body portion of the present tube body provides all electrical contacts for operation of the tube, and these are all axially aligned.

Accordingly, it is an object and advantage for this invention to provide an I^2T with an 20 axially-stacked high-voltage power supply which makes electrical connection to the tube via axially disposed contact pads of the tube body.

Further, it is an object for this invention to provide such an I^2T having a MCP which is free of an ion barrier film, and thus provides an improved level of signal-to-noise in the tube.

It follows that an object for and an advantage of this invention is the provision of an I^2T 25 which has an extraordinarily low level of image halo.

To this end, the present invention according to one aspect provides a night vision device comprising an image intensifier tube having a body holding: a photocathode, a microchannel plate, and a display electrode, the image intensifier tube receiving low-level or long wavelength light and responsively providing a visible image, the image intensifier tube comprising: the body including a 30 body ring-like portion defining a step upon which is disposed deformable electrical contact structure, this contact structure making electrical contact with the microchannel plate; and axially

extending insulative spacing structure extending between the photocathode and the microchannel plate and physically touching at least one of the microchannel plate and photocathode to trap the microchannel plate in a selected axial position on the step and establish a selected fine-dimension spacing between the microchannel plate and an active portion of the photocathode, and the body 5 further including a deformable and axially variable sealing portion sealingly uniting the body portion with a window member carrying the photocathode; whereby the axially variable sealing portion and deformable electrical contact structure cooperatively accommodate dimensional variability's for both the body portion and the window member, and the spacing dimension is independent of these dimensional variabilities.

10 The Applicant has discovered that, in contrast to the conventional technology, and by use of the present invention the spacing between the PC and the MCP in an I^2T may be reduced. This reduction of spacing dimension may be from about 50% of the conventional value to as much as essentially an order of magnitude less than the conventional and current spacing (i.e., to substantially about 25 μ meter or less). Most preferably, the gap from PC to MCP may be 15 reduced to as little as about 20 μ meter. The image halo image effect of the present image tube is correspondingly reduced in comparison to conventional I^2T 's.

Further, the I^2T according to the present invention may operate on lower applied voltages between the PC and MCP, so that the applied electric field between the PC and MCP is maintained at about the same level as that employed in conventional I^2T 's.

20 A further advantage results from the reduced electron energy necessary to introduce electrons into the microchannels of the MCP in comparison to conventional image intensifier tubes. Because the microchannels of an image intensifier tube embodying the present invention are open in the direction facing the photocathode (no ion barrier film is present to restrict electron entry) the photoelectrons have essentially no barrier to overcome. This is in contrast to 25 conventional proximity focused image intensifier tubes, which have an ion barrier on the input side of the MCP. As explained above, in conventional I^2T 's electrons must effectively penetrate the ion barrier to get into the microchannels of the conventional image intensifier tube. Thus, the voltage applied to the photocathode of an image tube operated according to the invention can be lowered, while still providing an adequate level of applied electric field, and while also still 30 providing an adequate flow of photoelectrons to the microchannel plate. This advantage allows use of a smaller and lower-voltage power supply.

Still further, serial manufacturing of image intensifier tubes embodying the present invention is made considerably easier and less expensive because the fine-dimension spacing of the photocathode from the microchannel plate is independent of dimensional variabilities of the window member and of the tube housing. In other words, while conventional image intensifier tubes depend upon control of tolerance stack-up dimensions for the components of the tube body in order to control the PC-to-MCP gap, the present invention allows a deformable structure to variably yield during manufacturing of the image intensifier tube, and by so yielding to compensate for tolerances of both the window member and of the tube body. The result is both a new freedom from the necessity to control dimensional tolerances of the window member and tube body to high standards, and a heretofore unobtainable precision and repeatability in establishing the fine-dimension PC-to-MCP gap.

These and additional objects and advantages of the present invention will be apparent from a reading of the following detailed description of preferred exemplary embodiments of the invention, taken in conjunction with the following drawing Figures, in which the same reference numbers refer to the same feature, or to features which are analogous in structure or function.

Brief Description of the Drawing Figures

Figure 1 provides a schematic representation of a night vision device having an image intensifier tube embodying the invention;

Figure 2 is a perspective view of an image intensifier tube embodying the present invention, and showing a front light-receiving window of the tube;

Figure 3 is a perspective view of the image intensifier tube seen in Figure 2, but is presented from the opposite end and shows a portion of an image output window of the tube within an annular high-voltage power supply of the tube;

Figure 4 is a fragmentary cross sectional view of the image intensifier tube seen in Figures 2 and 3, with portions of the structure rotated into the plane of this Figure for clarity of illustration;

Figure 5 provides a perspective view of the front, or light receiving side of a multi-layer laminated ceramic housing portion of the image intensifier tube seen in the preceding drawing Figures;

Figure 5a is a fragmentary cross sectional view taken at a line equivalent to 5a-5a of Figure 5, and also similar to a portion of Figure 4, but showing the image intensifier tube at a step of manufacturing;

Figure 6 is a perspective view of the multi-layer laminated ceramic housing portion of the image intensifier tube seen in Figure 5, but is taken from the opposite or image output side of the housing portion;

Figure 7 is a perspective view of a window portion of an image intensifier tube according to 5 the present invention;

Figure 8 is a fragmentary cross sectional view similar to Figure 4, but showing an alternative embodiment of the invention; and

Figure 9 is a greatly enlarged fragmentary view taken at an encircled portion of Figure 8.

10 **Detailed Description of the Preferred Exemplary Embodiments of the Invention**
Viewing Figure 1, a night vision device 10 includes a front objective lens 12 by which light 12a from a scene to be viewed is received. The light 12a is focused by the objective lens 12 through the front light-receiving window surface portion 14a of an image intensifier tube (I²T) 14. The transparent window surface portion 14a is defined by a transparent window member 16. The 15 I²T 14 includes a housing 18 enclosing an evacuated chamber 18a. The housing 18 is closed at the front or light receiving end by window member 16, and is similarly closed at a rear or image output end by a fiber optic window member 20. The window member 20 need not be fiber optic, but in this case includes fibers with a 180° twist over the thickness of the window member 20 so as to invert an image provided by the image intensifier tube 14. Within the chamber 18a is disposed a 20 photocathode (PC) 22 which is carried on the inner vacuum-exposed surface of the window member 16; a microchannel plate (MCP) 24, which is carried by the housing 18 and window member 16 cooperatively as will be explained; and a display electrode assembly 26, which is carried by the window member 20. The display electrode assembly 26 generally includes an electrode coating indicated with arrowed reference numeral 26a, and a phosphorescent material 28 25 associated with (i.e., by being coated onto) this electrode 26a.

Those ordinarily skilled in the pertinent arts will understand that the tube 14 need not be configured so as to produce a visible image directly. That is, instead of utilizing a display electrode assembly 26, a tube embodying the present invention may include, for example and without limitation, an electronic transducer or electronic image capture device. An example of such a 30 transducer or image capture device is a Charge Coupled Device (i.e., a CCD) which is able to respond to a flux of electrons from the MCP 24 by producing an electronic image signal. This image signal may be viewed, for example, on a liquid crystal display (i.e., an LCD), or the image

signal may be transmitted to a remote location, or may be viewed on a television monitor or on a CRT. Other examples of electronic transducers or image capture devices that may be utilized in a tube embodying the present invention include CMOS image sensors, and other detectors (such as ferroelectric detectors) which provide an electronic signal in response to an electron flux.

5 As will be seen, prevailing electrostatic fields are created within the I²T 14 by a power supply, generally referenced with the numeral 30. This power supply 30 includes a section 30a which provides a voltage differential between the PC 22 and a facial electrode 24a carried on the MCP 24. Another section 30b of the power supply 30 maintains a differential voltage between the electrode 24a and another facial electrode 24b carried on the opposite face of the MCP 24.
10 Finally, a power supply section 30c maintains a voltage differential between the facial electrode 24b and the electrode coating 26a. In each case, the differential voltages are most negative toward the left end of the I²T 14 as seen in Figure 1 (i.e., at the PC 22), and most positive toward the electrode 26a at the right side of this drawing Figure.

The photons of light 12a cause PC 22 to liberate photoelectrons 32 (also indicated on Figure 15 1 with the arrowed symbol e⁻) in a pattern which replicates the image of the scene focused by objective lens 12 thought window 16 and onto the PC 22. Photoelectrons from PC 22 move under the effect of the applied voltage field to MCP 24 and pass into microchannels of this MCP to cause proportionate release of secondary-emission electrons. These secondary-emission electrons are emitted in numbers far greater than the number of photoelectrons. Consequently, a shower 34 of 20 secondary-emission electrons is discharged from MCP 24, and proceeds to the electrode 26a under the effect of the applied voltage field. At the display electrode assembly, the shower of electrons 34 interacts with the phosphor material 28 to cause luminescence in a pattern which matches the image received on PC 22. The luminescence of the phosphor 28 provides visible light. Consequently, the image which is created at display electrode assembly 26 is conducted outwardly of the I²T 14 by 25 the image output window 20.

The device 10 also includes an eyepiece lens 36 which projects the image from the window 20 to a user of the device, who is indicated by the arrowed numeral 38 and the eye symbol in Figure 1.

Turning now to Figures 2 and 3 in conjunction with one another, it is seen that the I²T 14 30 includes a housing 18 which is generally cylindrical and round in end view. The window member 16 forms the front or light receiving end of the housing 18, and the window member 20

forms a comparatively smaller diameter opposite end of this housing 18. Carried on the housing 18 adjacent to and partially surrounding the window member 20 is an encapsulated high voltage power supply, the exterior encapsulation of which is indicated in Figure 2 by the numeral 30d. Within this encapsulation 30d, an electronic circuit 30 (recalling Figure 1) provides the high 5 voltage values that were diagrammatically indicated in Figure 1 with the reference numerals 30a, 30b, and 30c. An electrical connections, such as a cable 30e connects with the encapsulation 30d in order to provide electrical energy (i.e., such as from a battery) to the power supply circuit 30 to operate the I^2T 14. In Figure 3 it is seen that the encapsulation 30d for the power supply circuit 30 defines an opening 40 for an image passage 42 (indicated by dashed line on Figure 4) 10 allowing light from the display electrode assembly 26 to pass outwardly through the window member 20 and to the user 38 (i.e., via eyepiece lens 36 as well).

Further noting Figures 2 and 3, but turning attention now to Figure 4 as well, it is noted that the housing 18 of the I^2T includes a unitary laminated portion 44 which extends axially between the window portions 16 and 20. As will be further explained, this housing portion 44 15 defines a stepped through bore 44b, and is sealingly united with each of the window portions 16 and 20 in order to define the vacuum chamber 18a. Housing portion 44 also carries and provides for electrical interconnection of the I^2T 14 with the power supply circuit 30 (i.e., within encapsulation 30d). Thus, it is understood that the image intensifier tube 14 as seen in Figures 2, 3, and 4 is actually an assembly of the tube 14, and its encapsulated high-voltage power supply 20 30.

As Figure 4 illustrates, and viewing now Figures 5, 6, and 7 in conjunction with Figure 4, the housing portion 44 is defined cooperatively by a multitude of ceramic sub-layers, indicated collectively with the arrowed numeral 44a. In making of the housing portion 44, the multitude of green-state ceramic sub-layers 44a are fabricated individually, which allows them to be stacked and 25 laminated with one another while the ceramic material is in its green state. Subsequently, the stacked ceramic assembly which is to become the housing portion 44 is fired at an elevated temperature to permanently and sealingly bond the multiple ceramic sub-layers 44a into a unitary body, which upon completion of other manufacturing steps becomes the body portion 44. Consequently, it is seen that the housing portion 44 is unitary, and of a single piece of ceramic 30 (although this single piece of ceramic is of multiple layers and includes other structures). In this preferred embodiment, the housing portion 44 is fabricated principally of ceramic, but the invention

is not so limited. For example, glass might possibly be used to fabricate the housing portion 44.

Importantly, during the manufacturing operations leading to the creation of the unitary housing portion 44, plural conductive pathways or vias 46 are created in and through the ceramic material of the housing portion 44. These vias 46 may be created by providing metallic sections in 5 the respective sub-layers 44a which contact on another when these sub-layers are stacked together, for example. Alternatively, portions of ceramic material that are sufficiently loaded with conductive material that they will conduct the necessary voltage and current levels for the I²T 14 might be employed to construct the vias 46. Still more particularly, multiple conductive pathways 46 are created in the stacked thin ceramic sub-layers which, when these sub-layers are stacked and 10 interbonded to become a unitary body, connect with one another in the finished housing portion 44 as is described immediately below.

Thus, in order to connect the PC 22 outwardly of the I²T to the power supply 30, a conductive via 46a is created leading from a conductive, preferably metallic flange member 48, which is carried upon a planar annular front end surface 44c of the housing portion 44. 15 Conductive via 46a leads to a contact pad 50a (best seen in Figure 6) on the opposite planar annular end surface 44d of the housing portion 44. Similarly, in order to connect the electrode 26a outwardly on the housing 18, a conductive via 46b is created leading from a metallic flange 52 carried upon the planar annular rear end surface 44d of the housing portion 44 to a contact pad 50b (again best seen in Figure 6) on the rear end surface 44d. In this same way, vias 46c and 46d 20 extend from a step 54 defined inwardly of the housing portion 44 to respective contact pads 50c and 50d on the surface 44d. The window member 20 sealingly bonds to indium filled flange 52.

As is seen in Figure 4, the annular encapsulation 30d for the power supply circuit 30 abuts the surface 44d, and the power supply circuit 30 makes respective electrical contact with the contact pads 50a-d, recalling the schematic representation of Figure 1. It will be noted 25 viewing Figures 4 and 6 that for convenience of illustration, the contact pads 50a-d have all been shown in Figure 4 as residing in the plane of this cross sectional illustration. Figure 6, however, correctly shows that these contact pads are most preferably spaced circumferentially from one another about the circumference of the surface 44d. Also, it is to be noted that contact pads 50a and 50b are diametrically opposite to one another.

30 Considering Figures 4, 5, and 5a, it is seen that the step 54 carries an even number (six in this case) of circumferentially extending and circumferentially spaced apart metallized contact

areas 56. These contact areas 56 include three contact areas 56a alternating circumferentially with three contact areas 56b. The contact areas 56a are for connection with the electrode 24a, and the contact areas 56b are for connection with the electrode 24b. The contact areas 56a connect with via 46c and contact pad 50c, while the contact areas 56b connect with via 46d and 5 contact pad 50d. Consistently with the teaching of US patent No. 5,493,111, the microchannel plate 24 has a circumferentially discontinuous and circumferentially extending peripheral portion of electrode 24b which makes contact with the contact pads 56b.

Circumferentially intermediate or interdigitated on the same face of the MCP 24 with these portions of the electrode 24b are like circumferentially extending and discontinuous 10 portions of the electrode 24a. That is, a part 24a' (seen in Figure 5a) of the electrode 24a wraps around the outer circumferential periphery of the microchannel plate 24 to connect with a tab-like part of the electrode 24a which is disposed on the same side of this plate structure as is the electrode 24b. In other words, the MCP 24 has present on its output face electrical contacts for both the electrode 24a and for electrode 24b. For a complete discussion and disclosure of this 15 MCP construction, see US patent No. 5,493,111, owned by the assignee of this present application, and on which the inventor of this present application is also a joint inventor.

Further, viewing Figure 5a in greater detail, it is seen that upon the metallized contact areas 56a and 56b (i.e., on step 54), the housing portion 44 carries a deformable metallic contact pad structure, each indicated with the numeral 56'. These deformable contact pad structures 56' 20 are yieldable but shape-retaining, and are seen in Figure 5a at a time before the uniting of the window 16 and housing portion 44. In this preparatory condition, the contact pad structures 56' have a height that is greater than that seen in Figure 4. As will be explained, during 25 manufacturing of the I²T 14, the contact pad structures 56' are deformed from their as-manufactured, preparatory height as seen in Figure 5a, to a lesser height which is dependent upon dimensional variabilities in the components of the I²T 14.

Still considering Figures 5, 5a, and 6, and returning attention once again to Figure 4, it is seen that the MCP 24 is trapped upon step 54 and in electrical contact with the contact pads 56a, 56b. MCP 24 is trapped in this position by an axially extending insulative rim portion 22a which is integral with the photocathode structure 22. That is, the axially extending rim portion 22a is 30 insulative, circumferentially extending, and projects axially from (i.e., rightwardly in Figure 4) a position about an active surface area 22b of the MCP 22. This active surface area 22b is

centrally located in the photocathode structure 22 in order to align this surface area with the multitude of microchannels in the MCP 24. The active surface portion 22b is effective to release photoelectrons toward the MCP 24 when the PC is illuminated by light focused through the window member 16. Preferably, the insulative rim portion 22a extends axially about 20 microns 5 and has an axially disposed face (indicated with arrowed reference numeral 22c in Figure 6) which confronts and contacts the MCP to space this MCP away from the active surface area 22b. Further, it is seen in this respect that the MCP is carried by the housing portion 44 and PC 22 (on window member 16) in cooperation with one another.

Also seen in Figure 5a is a deformable annular seal structure 58. This seal structure is 10 carried by the metallic flange 48 and bonds deformably and sealingly with window member 16 when these parts are assembled. As is seen in Figure 5a, the seal structure 58 (similarly to contact pad structures 56') has a preparatory height that is higher than the completed height for this seal as seen in Figure 4. Most preferably, the contact pads 56' and deformable portion of seal structure 58 both employ a yieldable, sealingly deformable and bondable seal material 15 including indium metal. This seal material including indium metal will allow the deformable contact pad structures 56' and deformable seal structure 58 both to, yield, cold flow and sealingly cold weld when the components of I²T 14 are assembled. As Figure 5a shows, the MCP 24 is placed on step 54, with the electrodes 24a and 24b in electrical contact with the appropriate ones of the contact pads 56' and underlying contact areas 56a and 56b. Then the window member 16, 20 carrying PC 22 is positioned over the housing 44, and opposing forces (indicated by force arrows "F" in Figure 5a) are applied. The result is that the window member 16 bonds at seal structure 58 to metallic flange member 48, with the seal structure yielding and deforming to allow window member 16 to move axially toward housing 44. Simultaneously, the rib 22a contacts MCP 24, 25 and applies force through this MCP structure so that the contact pads 56' also yield, deform, and allow the MCP 24 to move toward step 54.

As this assembly process is being carried out, the spacing dimension between the active area 22b of the PC 22 and the MCP 24 is precisely maintained by the rim 22a. A variety of expedients may be used to control this bonding process. For example, a force-versus-displacement logging method may be used to plot the displacement of window member 16 30 toward housing 44. Alternatively, electrical conductivity between the MCP 24 and the contact areas 56 may be monitored. Still alternatively, a measurement of capacitance between PC 22 and

MCP 24 may be used to determine when the proper combination of deformation of the seal structure 58 and of the contact pads 56' has been achieved.

After the bonding process of Figure 5a has been completed, the power supply 30 is united with the housing 44 to make the completed I²T 14 as is seen in Figure 4. In order to electrically 5 connect the PC 22 to the seal structure 58 (and to metallic flange member 48, via 46a, and contact pad 50a) the window member 16 also carries a surface metallization, which is indicated with arrowed reference numeral 60. This surface metallization extends between the metallic flange member 48 and seal structure 58 and the outer peripheral portion of PC 22 which is exposed outwardly of peripheral rim 22a.

10 Again returning to consideration of Figure 6, it is seen that the contact pads 50a-d have a progressively more negative voltage toward the left side of this housing portion as seen in Figure 6, and a progressively more positive voltage toward the right side as seen in Figure 6. That is, the most negative contact pad is pad 50a, with pads 50c and 50d being diametrically opposite to one another, of intermediate voltage level and both lower in voltage level than pad 50a. Further, 15 both pads 50c and 50d are more negative than pad 50b, which is diametrically opposite to pad 50a. This arrangement of the pads 50a-d creates the lowest possible differential voltages between each of the contact pads 50a-d, and simplifies circuit arrangement in the power supply 30.

Figures 8 and 9 illustrate an alternative embodiment of the present invention. Because this 20 alternative embodiment has many features that are similar to those depicted and described above, these features and features which are analogous in structure or function to those described above, are indicated on Figures 8 and 9 with the same numeral used above, and increased by one-hundred.

Viewing now Figures 8 and 9, it is seen that an I²T 114 includes a housing 144. A window member 116 forms the front end of the housing 144, and a window member 120 forms an 25 opposite end of the housing. In this case, the power supply for the I²T 114 is not shown and this tube would use a conventional type of power supply which surrounds the tube. The housing 144 includes a body portion 144, which is fabricated using the multi-layer ceramic structure explained earlier. This housing portion 144 provides for electrical interconnection of the I²T 114 with the power supply circuit by providing contact tabs 150a, 150b, 150c, and 150d outwardly 30 exposed on the exterior surface of this housing portion.

The housing portion 144 defines a step 154 carrying an even number (again, six contact

areas may be used, but the invention is not so limited) metallized contact areas 156 (again, in two sets 156a and 156b). Upon the contact areas 156a and 156b the housing 144 carries respective deformable metallic contact pad structures 156'. The MCP 124 is trapped upon step 154 and in electrical contact with the contact pads 156a, 156b, as was explained above. An axially extending 5 insulative rim portion 122a of the PC 122 traps the MCP 124 on step 154 in contact with contact pads 156'.

However, in contrast to the embodiment of Figures 1-7, the alternative embodiment of Figures 8 and 9 provides for axial alignment of seal structures 152, and 158, respectively associated with the output window 120 and input window 116. Thus, as is seen in Figure 8 and 10 indicated by the force arrows "F" forces applied to the window member 116 and to the seal structure 152 as shown generally align with one another axially. In the case of the seal structure 152, this seal structure includes an annular metallic ring member 62, which is bonded to the window 120. This ring member 62 defines an annular basin or recess 64. Within the basin 64 is disposed an annular puddle 66 of sealing material including indium metal. This sealing material 15 was explained above with reference to seal structure 58. To the housing portion 144 is sealingly attached a ring member 68, which includes an axially projecting knife edge portion 70. As is seen in Figure 8, the knife edge portion 70 sealingly and bondingly sinks into puddle 66 because of assembly force "F."

Similarly, the seal structure 158 includes a ring member 148, which is bonded to the 20 housing portion 144. This ring member 148 defines an annular basin or recess 74. Within the basin 74 is disposed an annular puddle 76 of sealing material including indium metal. Figure 9 shows the seal structure 158 in a relationship and relative position preparatory to the uniting of these seal structure components to complete the structure seen in Figure 8.

Again, the MCP 124 is placed on step 154, with the electrodes 124a and 124b in electrical 25 contact with the appropriate ones of the contact pads 156' and underlying contact areas 156a and 156b. Then the window member 116, carrying PC 122 is positioned over the housing 144, and opposing forces (indicated by force arrows "F" in Figures 8 and 9) are applied. The result is that the window member 116 bonds at seal structure 158 to the housing 144, with the seal structure yielding and deforming to allow window member 116 to move axially toward housing 144. 30 Simultaneously, the rib 122a contacts MCP 124, and applies force through this MCP structure so that the contact pads 156' also yield, deform, and allow the MCP 124 to move toward step 154.

Once again, the MCP 122 and PC (i.e., window 116) both move axially and simultaneously toward the housing 144, maintaining the desired PC-to-MCP gap as the tube 114 is assembled.

While the present invention is depicted, described, and is defined by reference to preferred exemplary embodiments of the invention, such reference is not intended to imply a limitation on the invention, and no such limitation is to be inferred. The invention is subject to considerable modification and alteration, which will readily occur to those ordinarily skilled in the pertinent arts. For example, it is believed that the present invention can be implemented and practiced without making resource to the multi-layer unitary ceramic housing structure which is included in the preferred embodiments of the invention as presently disclosed. Further, the present invention is not limited to use in embodiments which produce an image directly for viewing at the tube. As was mentioned above, such devices as CCD's, CMOS image sensors, and other types of electronic transducers which will provide an image signal in response to an electron flux, may be used instead of or in addition to the display electrode assembly 26 of the present embodiments. Accordingly, the depicted and described preferred exemplary embodiments of the invention are illustrative only, and are not limiting on the invention. The invention is intended to be limited only by the spirit and scope of the appended claims, giving full cognizance to equivalents in all respects.